

#### **General Description**

The WSC15N10 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSC15N10 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

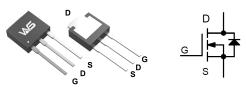
### **Product Summery**

BVDSS	RDSON	ID
100V	80mΩ	15A

#### Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

#### **TO-251 Pin Configuration**



Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	100	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	15	А
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> 11		А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup> 64		А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	30	mJ
I <sub>AS</sub>	Avalanche Current	6	А
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation <sup>3</sup>	60	W
P <sub>D</sub> @T <sub>C</sub> =100℃	Total Power Dissipation <sup>3</sup>	30	W
T <sub>STG</sub>	Storage Temperature Range -55 to 170		°C
TJ	Operating Junction Temperature Range -55 to 170		°C

#### **Thermal Data**

Symbol	Parameter	Typ. Max.		Unit	
R <sub>θJA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		50	°C/W	
R <sub>eJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		2.5	°C <b>/W</b>	

# Absolute Maximum Ratings



N-Ch MOSFET

#### Electrical Characteristics (T<sub>J</sub>=25<sup>1</sup>C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$ , I_D=1mA		0.098		V/℃
D	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =5A		80	100	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =2A		115	130	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.5	2.0	2.5	V
_V <sub>GS(th)</sub>	V <sub>GS(th)</sub> Temperature Coefficient	— V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-4.57		mV/℃
1	Drain Source Lookage Current	$V_{DS}$ =80V , $V_{GS}$ =0V , $T_{J}$ =25 $^{\circ}$ C			1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =5A		13		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2	4	Ω
Qg	Total Gate Charge (10V)	V <sub>DS</sub> =50V , V <sub>GS</sub> =10V , I <sub>D</sub> =5A	12	21	30	nC
Q <sub>gs</sub>	Gate-Source Charge		3.4	4.9	6.4	
Q <sub>gd</sub>	Gate-Drain Charge		2.9	5.8	8.7	
T <sub>d(on)</sub>	Turn-On Delay Time			13	24	
Tr	Rise Time	$V_{DD}$ =30V , $V_{GS}$ =10V , $R_{G}$ =6 $\Omega$		10	19	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =1A , RL=30Ω		32	60	ns
T <sub>f</sub>	Fall Time			16	30	
Ciss	Input Capacitance	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , f=1MHz		940		
C <sub>oss</sub>	Output Capacitance			80		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			50		

#### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy⁵	V <sub>DD</sub> =25V , L=0.5mH , I <sub>AS</sub> =6A	25			mJ

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			5	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	V <sub>G</sub> -V <sub>D</sub> -OV, Force Current			64	A
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =5A , T <sub>J</sub> =25℃			1.1	V
t <sub>rr</sub>	Reverse Recovery Time		33	47	61	nS
Qrr	Reverse Recovery Charge	IF=5A , dI/dt=100A/ $\mu s$ , T <sub>J</sub> =25 $^{\circ}$ C	61	87	113	nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t $\leq$ 10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25V, V_{\text{GS}}\text{=}10V, L\text{=}0.5\text{mH}, I_{\text{AS}}\text{=}6\text{A}$ 

4.The power dissipation is limited by 150  $^\circ\!\mathrm{C}$   $\,$  junction temperature

5. The Min. value is 100% EAS tested guarantee.

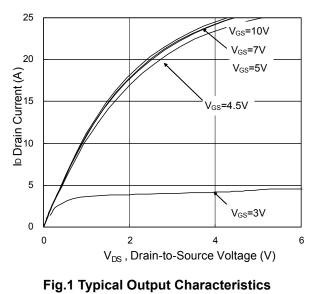
6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# WSC15N10

#### N-Ch MOSFET

## **Typical Characteristics**



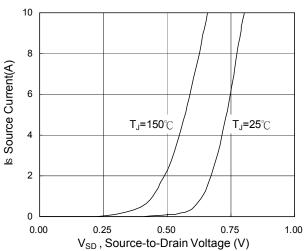


Fig.3 Forward Characteristics Of Reverse

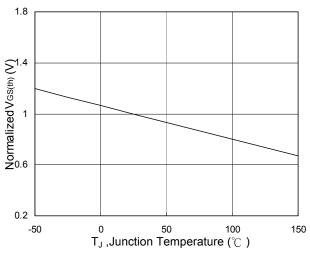


Fig.5 Normalized  $V_{GS(th)}$  vs. T<sub>J</sub>

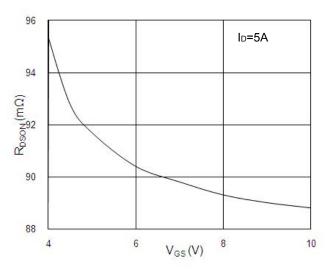


Fig.2 On-Resistance vs. Gate-Source

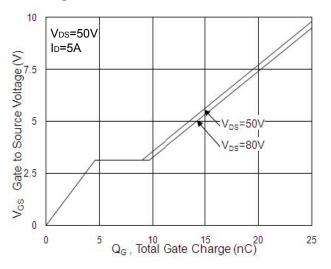


Fig.4 Gate-Charge Characteristics

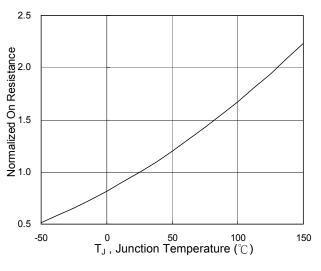


Fig.6 Normalized  $R_{\text{DSON}}$  vs.  $T_{\text{J}}$ 

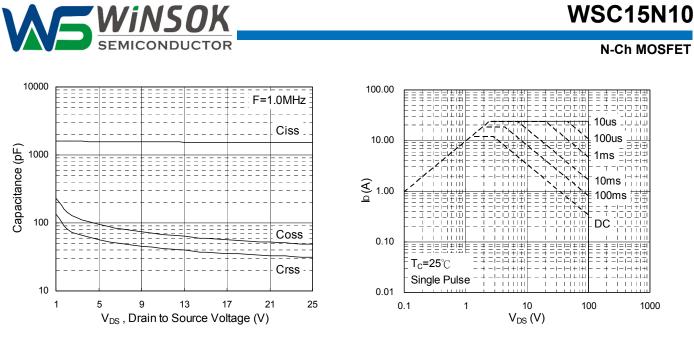
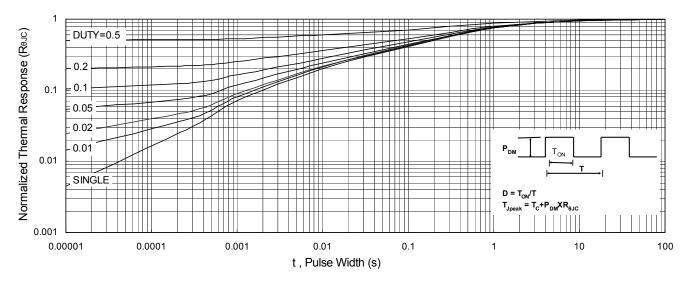
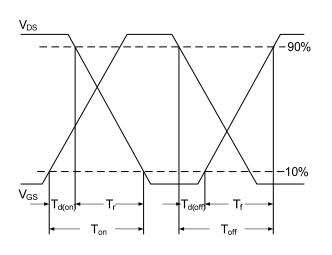


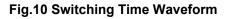


Fig.8 Safe Operating Area









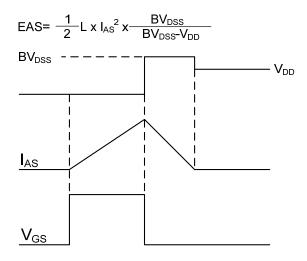


Fig.11 Unclamped Inductive Switching Waveform



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